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Docket No. 221014US90PCT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasuji HIRAMATSU, et al.

SERIAL NO: 10/070,443

GAU: 3742

FILED: June 24, 2002

EXAMINER: FUQUA, SHAWNTINA T

FOR: SEMICONDUCTOR MANUFACTURING/TESTING CERAMIC HEATER, PRODUCTION METHOD FOR THE CERAMIC HEATER AND PRODUCTION SYSTEM FOR THE CERAMIC HEATER

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

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SIR:

Applicant(s) wish to disclose the following information.

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REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☒ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the application(s) is attached along with PTO 1449.
- ☒ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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MAIER & NEUSTADT, P.C.

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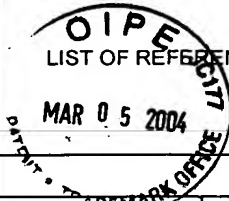
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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 221014US90PCT		SERIAL NO. 10/070,443	
				APPLICANT Yasuji HIRAMATSU, et al.			
				FILING DATE June 24, 2002		GROUP 3742	
<b>U.S. PATENT DOCUMENTS</b>							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,507,006	01/14/03	HIRAMATSU et al.			
	AB	6,465,763	10/15/02	ITO et al.			
	AC	6,677,557	01/13/04	ITO et al.			
	AD	6,475,606	11/05/02	NIWA			
✓	AE	US 2002/0043527 A1	04/18/02	ITO			
✓	AF	US 2003/0015521 A1	01/23/03	ITO			
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
<b>FOREIGN PATENT DOCUMENTS</b>							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO		
	AO						
	AP						
	AQ						
	AR						
	AS						
	AT						
	AU						
	AV						
<b>OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)</b>							
	AW						
	AX	<b>RECEIVED</b>					
	AY	MAR 11 2004					
	AZ	TECHNOLOGY CENTER R3700				<input type="checkbox"/> Additional References sheet(s) attached	
Examiner					Date Considered		
<small>*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>							



**LIST OF RELATED CASES**

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
221014US2 PCT*	10/070,443	06/24/02	HIRAMATSU, et al.
246909US-90-DIV	10/746,081 ✓	12/29/03	HIRAMATSU, et al.
247451US-90-DIV	10/755,308 ✓	01/13/04	HIRAMATSU, et al.
248168US90 CONT	10/766,027 ✓	01/29/04	ITO, et al.

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\*Present Application; listed for information  
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LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
PER CLIENT	09/471,759 ✓	12/23/99	SAITO et al.
PER CLIENT	09/462,067 ✓	01/05/01	FURUKAWA et al.
PER CLIENT	10/345,356 ✓	01/16/03	ITO
PER CLIENT	09/787,954 ✓	03/23/01	ITO
PER CLIENT	09/787,816 ✓	03/23/01	ITO
PER CLIENT	09/787,818 ✓	03/23/01	ITO
PER CLIENT	09/806,957 ✓	04/06/01	ITO et al.
PER CLIENT	09/926,730 ✓	04/16/01	HIRAMATSU et al.
PER CLIENT	09/880,742 ✓	06/13/01	SAITO et al.
PER CLIENT	09/880,359 ✓	06/13/01	SAITO et al.
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PER CLIENT	09/915,418 #	07/27/01	ITO
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PER CLIENT	09/917,749 ✓	07/31/01	ITO
PER CLIENT	09/958,689 ✓	10/10/01	FURUKAWA et al.
PER CLIENT	09/979,676 ✓	11/05/01	ZHOU
PER CLIENT	10/048,894 ✓	02/01/02	FURUKAWA
PER CLIENT	10/049,539 ✓	11/07/01	ZHOU
PER CLIENT	10/182,009 ✓	07/24/02	ZHOU

\*Present Application; listed for information

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PER CLIENT	10/222,928 /	08/19/02	ITO
PER CLIENT	10/265,413 ✓	10/07/02	OHASHI et al.
PER CLIENT	10/356,519 ✓	02/03/03	ITO
PER CLIENT	10/217,029 *	08/13/02	ITO
205232US0 PCT	09/806,477 ✓	06/25/01	ITO et al.
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205240US0 PCT	09/807,960 ✓	05/18/01	HIRAMATSU et al.
209243US0 PCT	6,507,006	01/14/03	HIRAMATSU et al.
211598US2 PCT	09/869,321 /	10/18/01	ZHOU
212145US0 PCT	6,465,763	10/15/02	ITO et al.
212814US3 PCT	09/926,012 ✓	10/24/01	HIRAMATSU et al.
213163US2 PCT	09/926,092 ✓	12/27/01	ITO et al.
214768US90 PCT	09/926,297 ✓	12/26/01	HIRAMATSU et al.
214810US90 PCT	09/926,296 ✓	12/27/01	ITO et al.
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215811US0 PCT	09/926,464 ✓	01/10/02	HIRAMATSU et al.
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216714US2 PCT	09/926,714 /	03/05/02	ITO et al.
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217551US2 PCT	10/019,448 /	04/08/02	ITO et al.
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220253US2 PCT	10/069,511 ✓		06/24/02	ITO et al.
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221015US2 PCT	10/070,441 ✓		06/26/02	ITO et al.
221158US2 PCT	10/088,098 ✓		05/30/02	ITO et al.
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222661US3 PCT	10/111,980 ✓		06/27/02	ITO et al.
223945US0 PCT	10/168,527 ✓		10/18/02	HIRAMATSU et al.
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231910US90 PCT	10/311,368 ✓		05/09/03	ITO et al.
232028US3 DIV	10/352,138 ✓		01/28/03	HIRAMATSU et al.
232736US0 CONT	10/346,095 ✓		01/17/03	ITO et al.
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235401US90 CONT	10/397,321 ✓	03/27/03	HIRAMATSU et al.
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245199US90 CONT	10/718,535	✓	11/24/03	HIRAMATSU et al.
246481US90 PCT	09/673,953	✓	12/21/00	ITO et al.
246590US90 DIV	10/732,296	✓	12/11/03	ITO et al.

\*Present Application; listed for information

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